

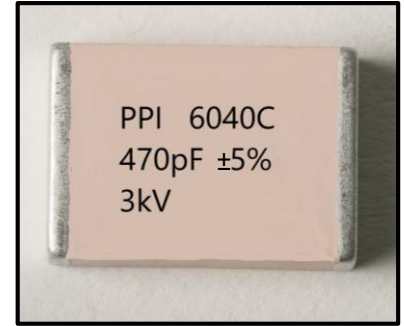


≠ Product Features

- High Q
- High RF Current/Voltage
- Ultra Stable Performance
- Capacitance Range:
1.0pF to 6800pF
- Working Voltage: 5000V
- Extended Voltage: 8000V

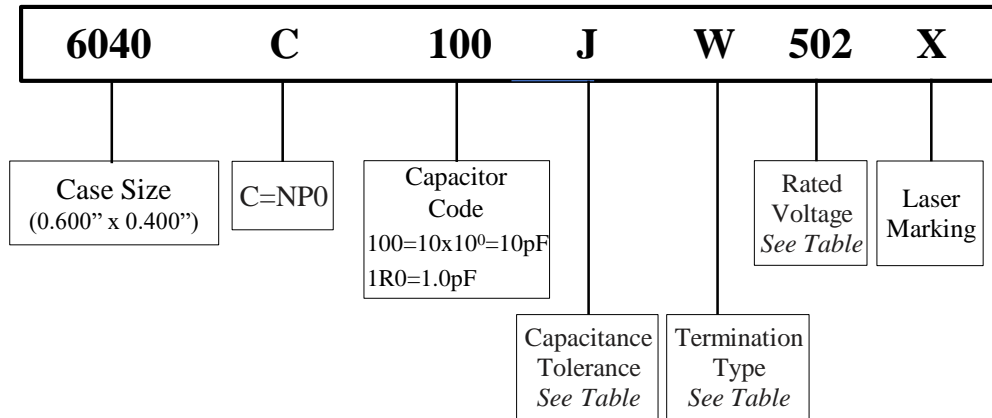
≠ Typical Circuit Applications

- Semiconductor Manufacturing
- High Energy Power Transfers
- Plasma Chambers
- Medical Equipment



Marking shown for illustration purposes only.
Actual marking may differ.

≠ Part Numbering



≠ Capacitance Tolerance Codes

Code	B	C	D	F	G	J	K
Tol.	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%

≠ Voltage Codes

Voltage	Code
1000V	102
2000V	202
3000V	302
5000V	502
8000V	802

Please note that the contents of this document are subject to change at any time at PPI's sole discretion. The most up-to-date version of this document is available at www.passiveplus.com.



UHF/RF High-Q Power Transmitter
Multi-Layer Ceramic Capacitors

6040C (0.600" x 0.400")

± 6040C Capacitance Values

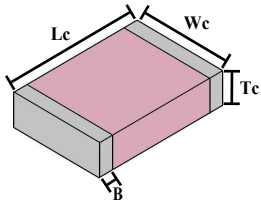
For special capacitances, tolerances and WVDC, please contact PPI.



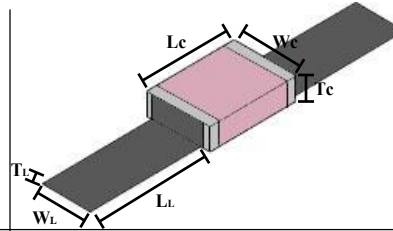
Marking shown for illustration purposes only.
Actual marking may differ.

Cap. pF	Cap Code	Tol.	Rated WVDC		Cap. pF	Cap Code	Tol.	Rated WVDC		Cap. pF	Cap Code	Tol.	Rated WVDC	
			Std.	Ext.				Std.	Ext.				Std.	Ext.
1.0	1R0	B,C, D	5000V	8000V	39	390	F,G, J,K	5000V	8000V	1500	152	F,G, J,K	2000V	3000V
1.2	1R2				47	470				1800	182			
1.5	1R5				56	560				2200	222			
1.8	1R8				68	680				2700	272			
2.2	2R2				82	820				3300	332			
2.7	2R7				100	101				4700	472			
3.3	3R3				120	121				5100	512			
3.9	3R9				150	151				5600	562			
4.7	4R7				180	181				6800	682			
5.6	5R6				220	221								
6.8	6R8	F,G, J,K	5000V	8000V	270	271	F,G, J,K	3000V	5000V					
8.2	8R2				330	331								
10	100				390	391								
12	120				470	471								
15	150				560	561								
18	180				680	681								
22	220				820	821				F,G, J,K	2000V	3000V		
27	270				1000	102								
33	330				1200	122								

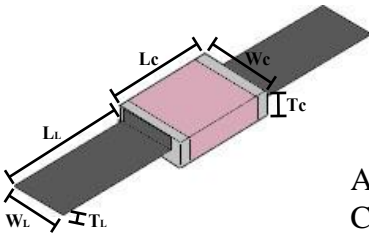
≠ Termination Types and Codes



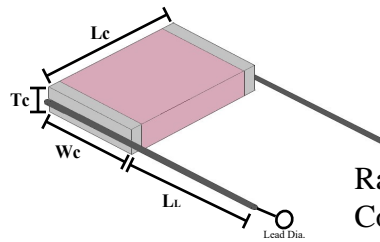
Chip Termination:
Codes: **W, L, P**



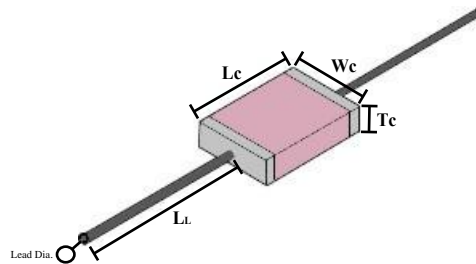
Microstrip Termination:
Codes: **MS, MN**















Axial Ribbon Termination:
Code: **AR, AN**



Radial Wire Termination:
Codes: **RW, RN**



Axial Wire Termination:
Codes: **AW, BN**

Termination Code	Magnetic Termination	Termination Code	Non-Magnetic  Termination
W 	100% Tin Solder over Nickel Barrier	P 	100% Tin Solder over Copper Barrier
L	90%Tin/10%Lead Solder over Nickel Barrier	MN 	Silver-Plated Copper
MS 		AN 	
AR 		RN 	
RW 	Silver-Plated Copper	BN 	
AW 		 Note: "Non-Magnetic" means no magnetic materials.	



≠ **Dimensions** - For Termination Types images, see previous page Unit: inch (millimeter)

Magnetic Termination								
Code		Capacitor Dimensions				Lead Dimensions		
		Length	Width	Thickness	Overlap	Length	Width	Thickness
		Lc	Wc	Tc	B	LL	WL	TL
W/L	Chip	0.614 (15.6)	$\begin{matrix} +0.015 \\ -0.010 \\ +0.38 \\ -0.25 \end{matrix}$	0.433 ± 0.010 (11.0 ± 0.25)	0.154 ± 0.008 (3.90 ± 0.20)	0.063 max (1.60 max)	-	-
MS	Microstrip						0.787 min (20.0 min)	0.350 ± 0.010 (8.89 ± 0.50)
AR	Axial Ribbon	0.614	$\begin{matrix} +0.015 \\ -0.010 \end{matrix}$	0.433 ± 0.010	0.154 ± 0.008	-	0.787 min (20.0 min)	0.350 ± 0.010 (8.89 ± 0.50)
RW	Radio Wire	(15.6)	$\begin{matrix} +0.38 \\ -0.25 \end{matrix}$	(11.0 ± 0.25)	(3.90 ± 0.20)		0.787 min (20.0 min)	Dia. = 0.030 ± 0.004
AW	Axial Wire						0.984 min (25.00 min)	Dia. = (0.80 ± 0.10)

Non-Magnetic Termination								
Code		Capacitor Dimensions				Lead Dimensions		
		Length	Width	Thickness	Overlap	Length	Width	Thickness
		Lc	Wc	Tc	B	LL	WL	TL
P	Chip	0.614 (15.6)	$\begin{matrix} +0.015 \\ -0.010 \\ +0.38 \\ -0.25 \end{matrix}$	0.433 ± 0.010 (11.0 ± 0.25)	0.154 ± 0.008 (3.90 ± 0.20)	0.063 max (1.60 max)	-	-
MN	Microstrip						0.787 min (20.0 min)	0.350 ± 0.010 (8.89 ± 0.50)
AN	Axial Ribbon	0.614	$\begin{matrix} +0.015 \\ -0.010 \end{matrix}$	0.433 ± 0.010	0.154 ± 0.008	-	0.787 min (20.0 min)	0.350 ± 0.010 (8.89 ± 0.50)
RN	Radio Wire	(15.6)	$\begin{matrix} +0.38 \\ -0.25 \end{matrix}$	(11.0 ± 0.25)	(3.90 ± 0.20)		0.787 min (20.0 min)	Dia. = 0.030 ± 0.004
BN	Axial Wire						0.984 min (25.00 min)	Dia. = (0.80 ± 0.10)

⊘ Note: Non-Magnetic means no magnetic materials. All leads are attached with high temperature solder and parts are RoHS Compliant.



≠ Electrical Specifications

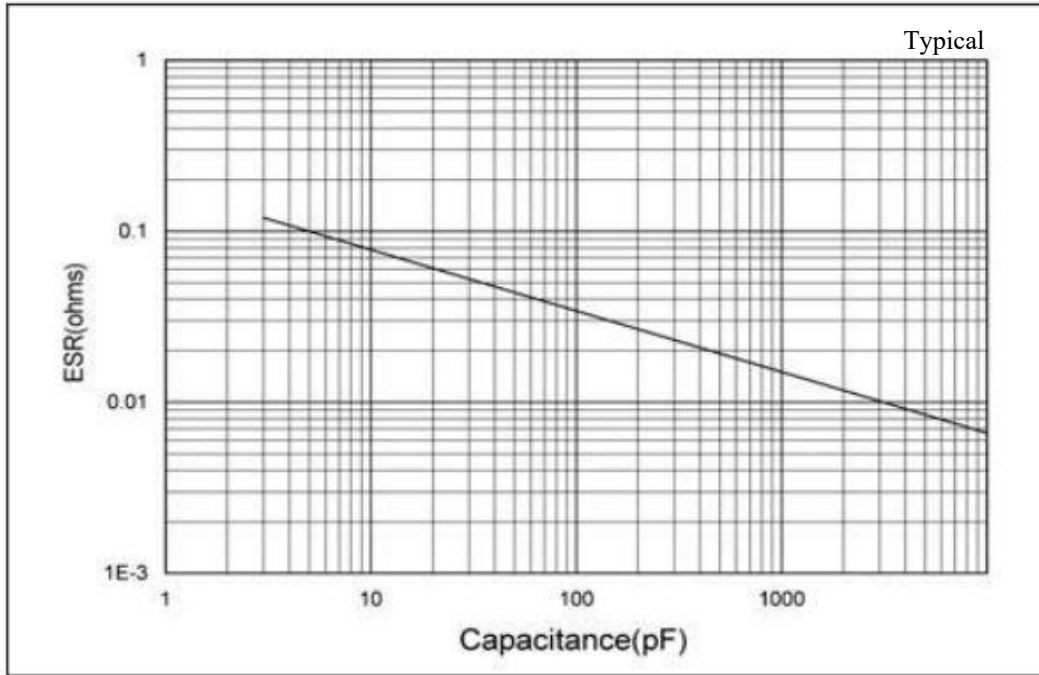
Quality Factor (Q)	No less than 1000pF, Q value more than 2000, Test Frequency 1MHz More than 1000pF, Q value more than 2000, Test Frequency 1kHz
Insulation Resistance (IR)	Test Voltage: 500V 10 ⁵ Megaohms min. @ +25°C 10 ⁴ Megaohms min. @ +125°C
Rated Voltage	See Rated Voltage in Capacitance Table
Dielectric Withstanding Voltage (DWV)	250% of Voltage of 5 seconds, Rated Voltage ≤ 500VDC 150% of Voltage for 5 seconds, 500VDC < Rated Voltage ≤ 1250VDC 120% of Voltage for 5 seconds, Rated Voltage > 1250VDC
Operating Temperature Range	-55°C to 175°C
Temperature Coefficient (TC)	-55°C to 125°C 0±30ppm/°C >125°C to 175°C 0±60ppm/°C
Capacitance Drift	±0.02% or ±0.02pF, whichever is greater
Piezoelectric Effects	None
Termination Type	See Termination Type Table

≠ Environmental Specifications

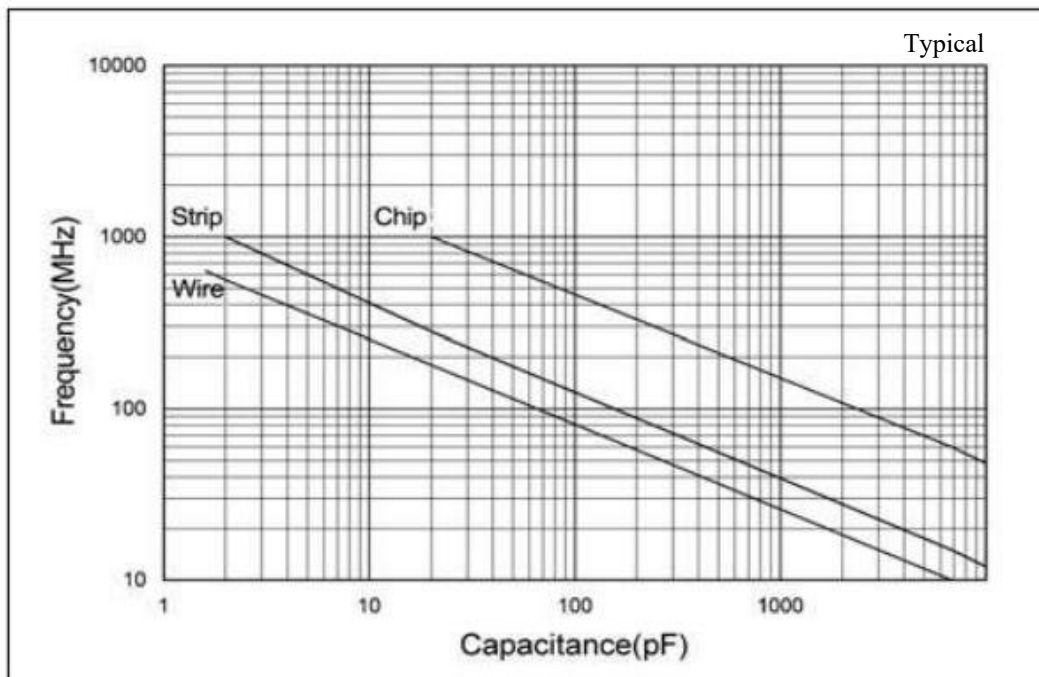
	Specification	Test Parameters
Thermal Shock	DWV: The initial value IR: Shall not be less than 30% of the initial value. Capacitance Change:	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.
Moisture Resistance	No more than 0.5% or 0.5pF, whichever is greater.	MIL-STD-202, Method 106
Humidity (Steady State)	DWV: The initial value IR: The initial value Capacitance Change: No more than 0.3% or 0.3pF, whichever is greater.	MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.
Life	IR: Shall not be less than 30% of the initial value. Capacitance Change: No more than 2.0% or 0.5pF, whichever is greater.	MIL-STD-202, Method 108. For 2000 hours, at 125°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC < Rated Voltage ≤ 1250VDC; 100% for Voltage for Capacitors, Rated Voltage > 1250VDC
Terminal Strength	Force: 25lbs typical, 20lbs. min. Duration Time: 5 to 10 seconds	MIL-STD-202, Method 211A, Test Condition A. Applied a force and maintained for a period of 5 to 10 seconds. The force shall be in the direction of the axes of the terminations.

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

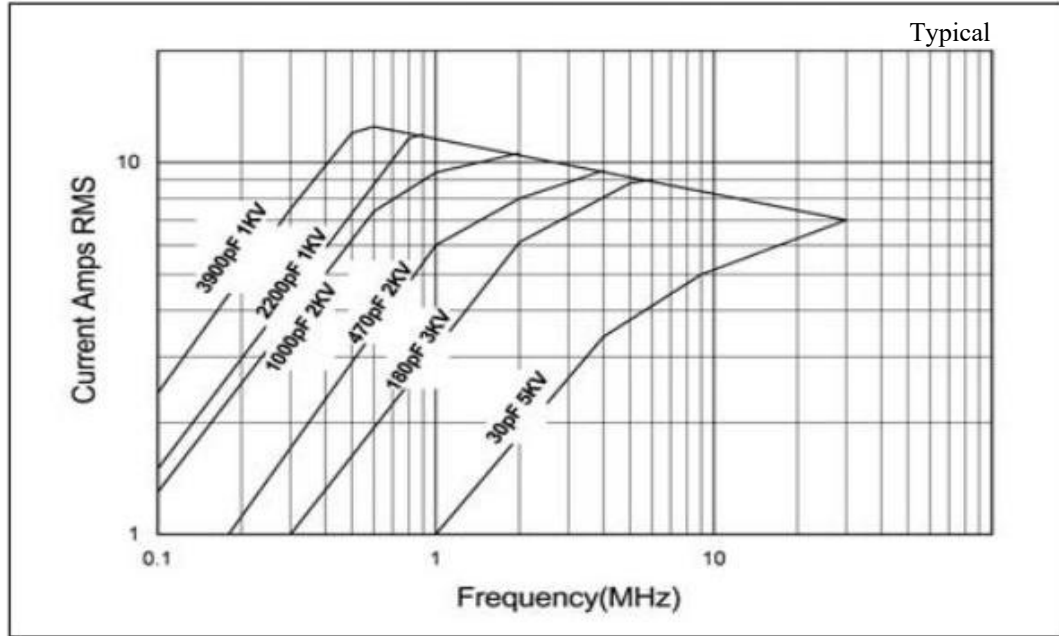
≠ ESR vs. Capacitance Measured @ 30MHz



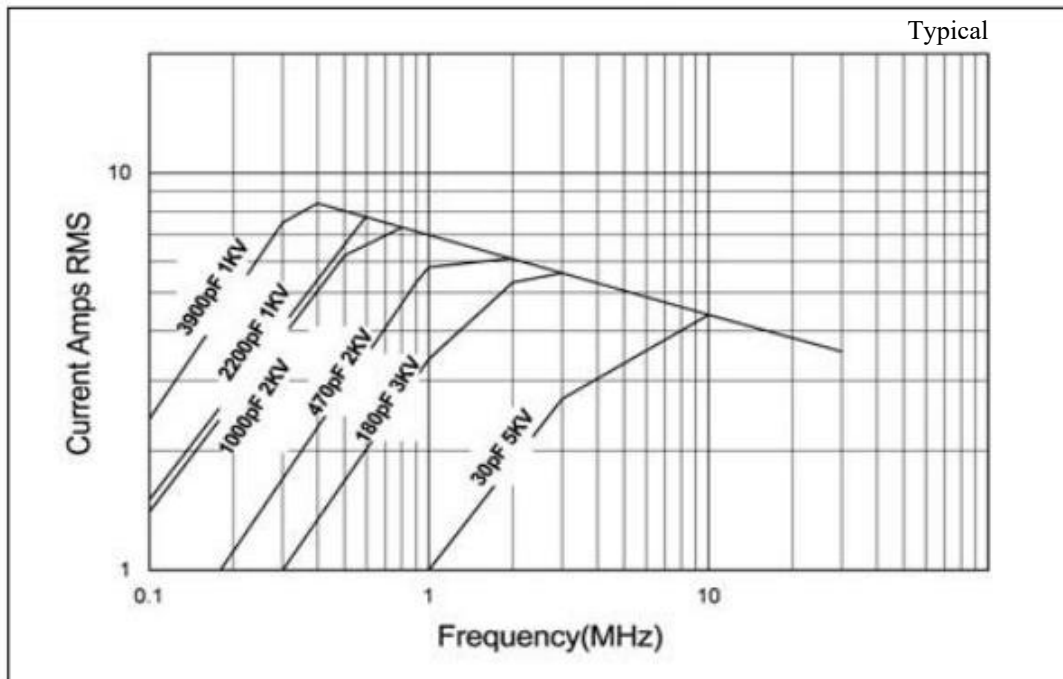
≠ Self Resonant Frequency vs. Capacitance



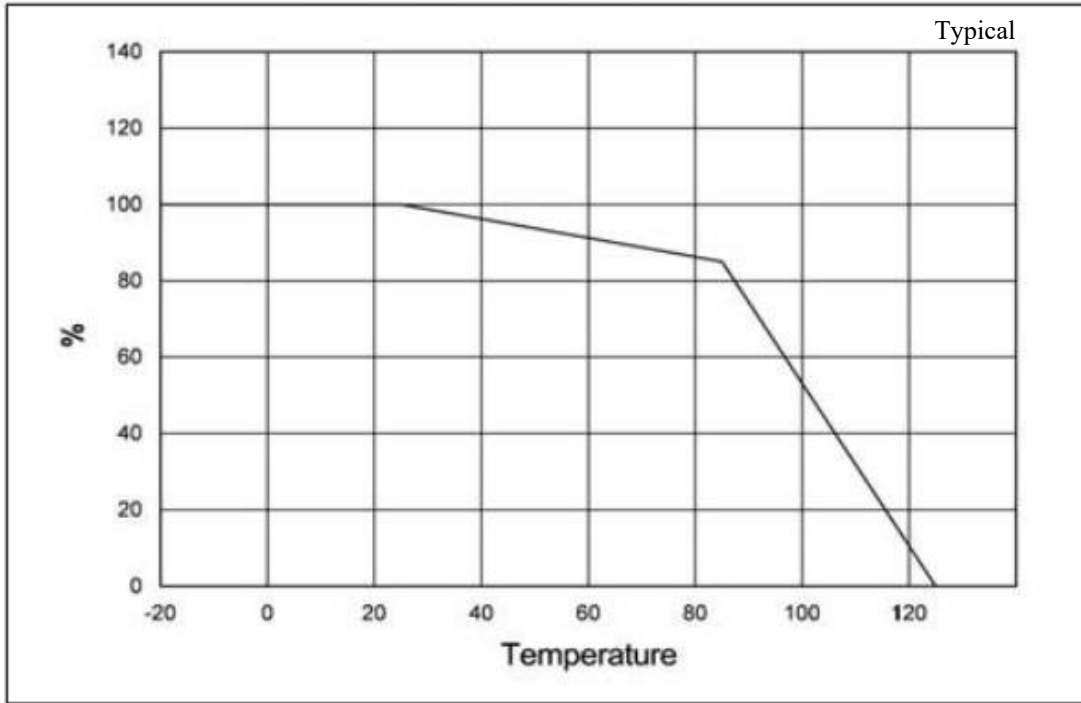
≠ Strip Terminals Rated Current vs. Frequency



≠ Wire Terminals Rated Current vs. Frequency



≠ % Maximum Current vs. Ambient Temperature



≠ Recommended Land Pattern Dimensions

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).

≠ Custom Assemblies

Passive Plus offers Capacitor Assemblies for high power requirements. Typical assemblies are configured in series and/or parallel combinations, producing higher voltage/current handling capabilities, extended capacitance range and tighter tolerances.

To get started, simply send us either a mechanical drawing or circuit conditions and we can recommend a solution. All components are 100% up-screened for Partial Discharge and Sonoscanned. All assemblies include a 100hr Military burn in.

